Ordering Information

Part Number	Package Option	Packing				
HV809K2-G	7-Lead TO-220	50/Tube				
HV809LG-G	8-Lead SOIC	2500/Reel				
HV809SG-G	8-Lead SOIC w/ heat slug	2500/Reel				

⁻G denotes a lead (Pb)-free / RoHS compliant package

Absolute Maximum Ratings

Parameter	Value
HV _{IN} , High voltage input	+210V
V _{DD} , Internal supply voltage	+15V
Operating temperature range	-25°C to +85°C
Storage temperature range	-55°C to +150°C
Power dissipation:	
8-Lead SOIC	500mW
8-Lead SOIC w/ Heat Slug	1.5 Watts
7-Lead TO-220*	15Watts

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

Product Marking



L = Lot Number
YY = Year Sealed
WW = Week Sealed
_____ = "Green" Packaging

Package may or may not include the following marks: Si or 🌎

7-Lead TO-220

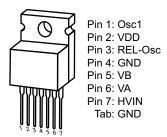


Y = Last Digit of Year Sealed WW = Week Sealed L = Lot Number _____ = "Green" Packaging

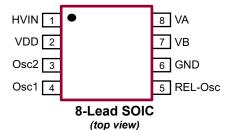
Package may or may not include the following marks: Si or 4

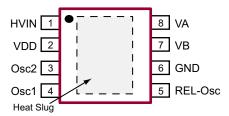
8-Lead SOIC

Pin Configuration



7-Lead TO-220 (front view)





8-Lead SOIC w/ Heat Slug (top view) (Heat slug is at ground potential)

Typical Thermal Resistance

Package	$oldsymbol{ heta}_{ja}$
7-Lead TO-220	29°C/W
8-Lead SOIC	101°C/W
8-Lead SOIC w/ heat slug	84°C/W

Recommended Operating Conditions

Sym	Parameter	Min	Тур	Max	Units	Conditions
HV_{IN}	High voltage input	50	-	200	V	
	Load conscitones	-	-	350	nF	R _{EL} = 1.0MΩ, HV _{IN} = 170V
C_{\scriptscriptstyleL}	Load capacitance	-	-	150	nF	R _{EL} = 390kΩ, HV _{IN} = 170V
T _A	Operating temperature	-25	-	85	οС	

^{*} With external heat sink mounted, refer to App Note AN-H36.

Electrical Characteristics

DC Characteristics (Over recommended operating conditions unless otherwise specified - T_A = 25°C)

Sym	Parameter	Min	Тур	Max	Units	Conditions
	High voltage cumply current	-	-	70	mA	$HV_{IN} = 170V, R_{EL} = 1.0M\Omega, C_{L} = 350nF$
I _{IN}	High voltage supply current	-	-	9.0	mA	$HV_{IN} = 170V, R_{EL} = 1.0M\Omega, C_{L} = 50nF$
	Ouigneent ounnly ourrent	-	-	400	μA	HV_{IN} = 170V, R_{EL} = 1.0M Ω , Osc1 = GND, No Load
I _{INQ}	Quiescent supply current	-	-	100	μA	$HV_{IN} = 170V, R_{EL} = 1.0M\Omega,$ $Osc1 = V_{DD}, No Load$
ISINK	Osc2 sink current*	-	300	-	μA	V _{Osc2} = 1.0V
SOURCE	Osc2 source current*	-	100	-	μA	$V_{Osc2} = V_{DD} -1.0V$
l _{Osc1}	Osc1 logic input leakage current	-	±10	-	μA	V_{Osc1} = GND and V_{DD}
V _{Osc1(hyst)}	Osc1 hysteresis voltage	-	2.5	-	V	
V _{A-B}	Min differential output voltage across lamp	-	-	400	V	HV _{IN} = 200V
V _{DD}	Internal supply voltage	8.0	10	12	V	No load on V _{DD}
I _{DD (OUT)}	Output V _{DD} current	4.0	-	-	mA	For HV809K2, $\Delta V_{DD} = 1.0V$

^{*} $\rm I_{SINK}$ and $\rm I_{SOURCE}$ are not valid for the TO-220 package.

AC Characteristics (Over recommended operating conditions unless otherwise specified - T_A = 25°C)

Sym	Parameter	Min	Тур	Max	Units	Conditions
f	V output drive frequency	320	400	480	Hz	R_{EL} = 1.0M Ω , Osc1 = GND, C_L = 350nF
f _{EL}	V _{A-B} output drive frequency	0.8	1.0	1.2	kHz	$R_{EL} = 390k\Omega$, Osc1 = GND, $C_L = 150nF$
t _r	Output rise time	-	180	250	μs	C _L = 150nF, HV _{IN} = 170V
t _f	Output fall time	-	50	100	μs	C _L = 150nF, HV _{IN} = 170V

Function Table

Input	Outputs								
Osc1	VA	VB							
GND	Enabled	Enabled							
VDD	Disabled	Disabled							

Figure 1. AC Off-Line EL Lamp

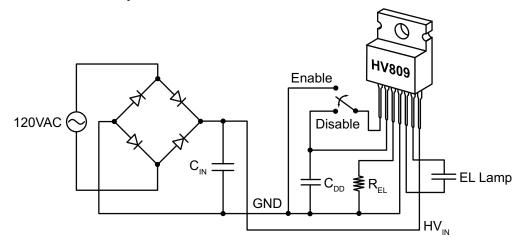


Figure 2. Pulsing EL Lamp

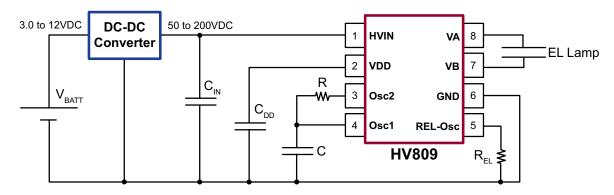
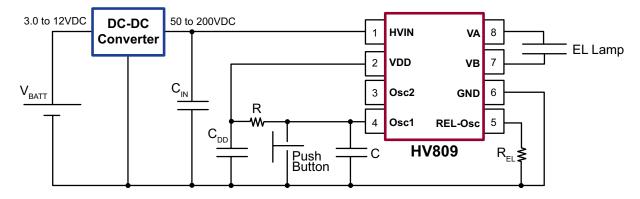
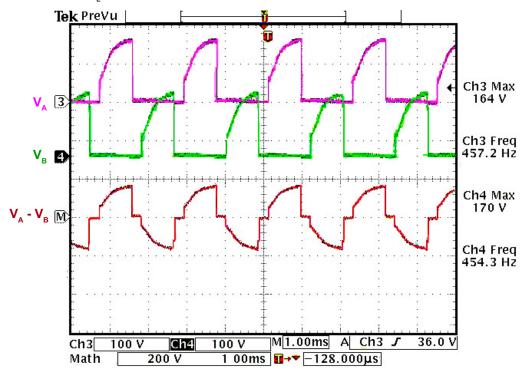


Figure 3. Push-Button, Delayed Turn Off



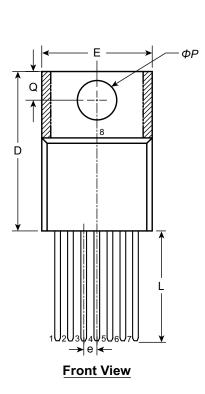
Typical Waveform on V_A , V_B , and Differential Waveform V_A - V_B (HV_{IN} = 170V, R_{EL} = 1.0M Ω , and C_L = 350nF)

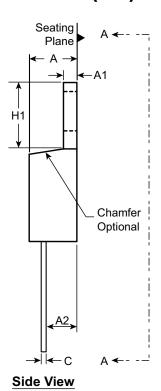


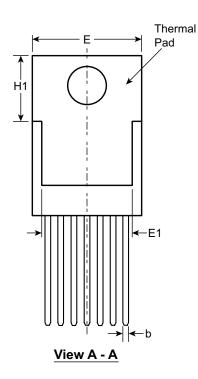
Function Table

Pin Name	Description
Osc1	The Output H-bridge can be enabled and disabled by connecting the Osc1 pin to the GND and VDD pins. The output can be left enabled by connecting the Osc1 pin to GND.
Osc2	The RC network can be connected between the oscillator's Osc1 and Osc2 pins to pulse the EL lamp on and off.
VDD	Internal supply voltage.
REL-Osc	EL lamp frequency is controlled via an external R_{EL} resistor connected between the REL-Osc and GND pins of the device.
VB	VB side of the EL lamp driver H-bridge. Connection for one of the EL lamp terminals.
VA	VA side of the EL lamp driver H-bridge. Connection for one of the EL lamp terminals.
HVIN	High voltage input supply pin.
GND	Ground pin.

7-Lead TO-220 Package Outline (K2)







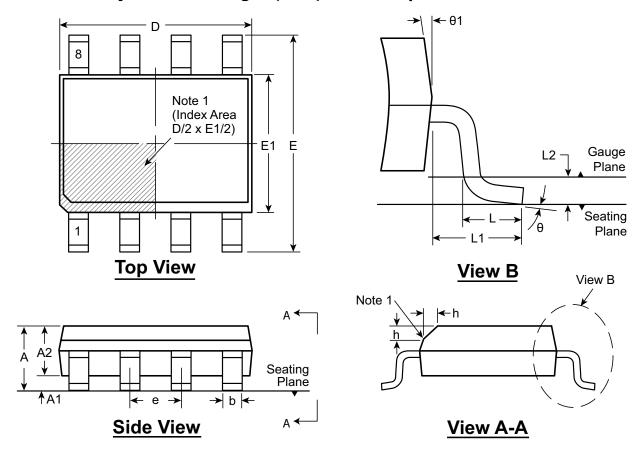
Symbol		Α	A1	A2	b	С	D	E	E1	е	H1	L	Q	ΦР
Dimension (inches)	MIN	.160	.045	.090	.023	.015	.560	.385		.045	.234	.540	.103	.146
	NOM	-	-	-	-	-	-	-	.300 REF	-	-	-	-	-
	MAX	.190	.055	.115	.037	.022	.590	.415		.055	.258	.560	.113	.156

Drawings not to scale.

Supertex Doc. #: DSPD-7TO220K2, Version NR090308.

8-Lead SOIC (Narrow Body) Package Outline (LG)

4.90x3.90mm body, 1.75mm height (max), 1.27mm pitch



Note:

This chamfer feature is optional. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbo	I	Α	A 1	A2	b	D	E	E1	е	h	L	L1	L2	θ	θ1
Dimension (mm)	MIN	1.35*	0.10	1.25	0.31	4.80*	5.80*	3.80*		0.25	0.40			0 o	5 °
	NOM	-	-	-	-	4.90	6.00	3.90	1.27 BSC	1	ı	1.04 REF	0.25 BSC	-	-
()	MAX	1.75	0.25	1.65*	0.51	5.00*	6.20*	4.00*		0.50	1.27			8 º	15°

JEDEC Registration MS-012, Variation AA, Issue E, Sept. 2005.

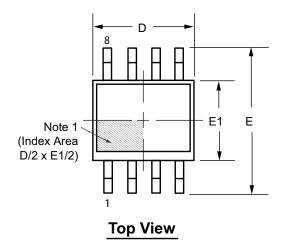
* This dimension is not specified in the JEDEC drawing.

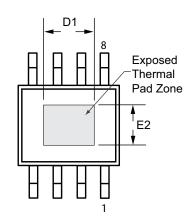
Drawings are not to scale.

Supertex Doc. #: DSPD-8SOLGTG, Version 1041309.

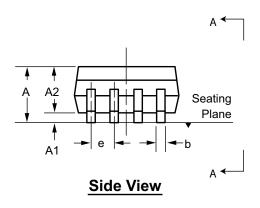
8-Lead SOIC (Narrow Body w/Heat Slug) Package Outline (SG)

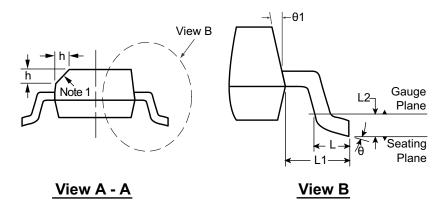
4.90x3.90mm body, 1.70mm height (max), 1.27mm pitch





Bottom View





Note:

1. If optional chamfer feature is not present, a Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbo	ol	Α	A1	A2	b	D	D1	Е	E1	E2	е	h	L	L1	L2	θ	θ1
	MIN	1.25*	0.00	1.25	0.31	4.80*	3.30 [†]	5.80*	3.80*	2.29 [†]		0.25	0.40			0 °	5°
Dimension (mm)	NOM	-	-	-	-	4.90	-	6.00	3.90	-	1.27 BSC	-	-	1.04 REF	0.25 BSC	-	-
(11111)	MAX	1.70	0.15	1.55*	0.51	5.00*	3.81 [†]	6.20*	4.00*	2.79 [†]	200	0.50	1.27	'_'	30	8 º	15°

JEDEC Registration MS-012, Variation BA, Issue E, Sept. 2005.

Drawings not to scale.

Supertex Doc. #: DSPD-8SOSG, Version D041009.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

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^{*} This dimension is not specified in the JEDEC drawing.

[†] This dimension differs from the JEDEC drawing.